

**REMARKS**

The Examiner is thanked for the careful review of this application. Claims 1, 4, 5, 8, 11, 12, 15, 18, 19, 32, and 33 are pending after entry of the present Amendment. Claims 2, 3, 9, 10, 16, 17, and 31 were cancelled. Claims 6, 7, 13, 14, and 20-30 were previously cancelled. Amendments were made to claims to better define what Applicants claim to be the invention and to comply with the requirements set forth in the Office Action. These amendments do not introduce any new matter, and as such, do not require a new search.

**Claim Rejections under 35 U.S.C. § 112, First Paragraph:**

The Office has rejected claims 1-5, 8-12, 15-19, and 31-32 under 35 U.S.C. § 112, first paragraph asserting that the claims are based on a disclosure which is not enabling. Specifically, the Office asserts that the claims lack any biased or other centrifugally operative structure.

The Applicants respectfully traverse the Office's assertion. However, to expedite the prosecution process and for clarity, the Applicants have amended independent claims 1, 8, 15, and 32 to recite biased or centrifugally operative structure by specifically including the height adjustment slot included in the shaft, the pin included in the cylindrical edge lip of the wafer backside plate, the pin engaging the height adjustment slot, and the capability of the pin to slide within the height adjustment slot. Of course, it is respectfully submitted that the pin and the height adjustment slot provided in the specification are exemplary structures that can be implemented to cause the wafer backside plate move to second and first positions. As such, any appropriate technique may be implemented to cause the wafer backside plate move to second and first positions. For instance, any equivalent structure can be implemented instead of the pin and any equivalent structure can be implemented instead of the height adjustment slot so long as the equivalent pin structure can connect to the equivalent height adjustment slot structure and move within the equivalent height adjustment slot structure, causing the wafer backside plate move to second and first positions. Accordingly, the Applicants submit that the apparatus defined in independent claims 1, 8, 15, and 32 are enabled in view of the description provided in the specification of the subject application.

**Claim Rejections under 35 U.S.C. § 112, Second Paragraph:**

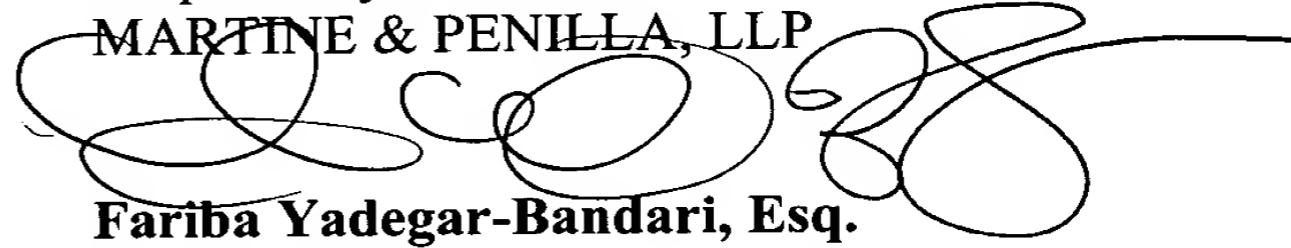
The Office has rejected claim 33 as being indefinite for failing to point out the manner the wafer interconnects or relates to the apparatus. The Applicants have amended

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claim 33 to specifically define the wafer backside plate under a wafer location position, thus specifically reciting the interconnection and relation of the wafer location with respect to the apparatus. As such, the rejection of independent claim 33 under 35 U.S.C. section 112, second paragraph should be withdrawn.

The Applicants submit that this Response to Final Office Action complies with 37 C.F.R. § 1.116(b) and should be entered. The remarks and the amendments do not raise any new issues. Accordingly, the Applicants respectfully request entry of this Amendment.

In view of the foregoing, the Applicants respectfully submit that all of the pending claims are in condition for allowance. Accordingly, a Notice of Allowance is respectfully requested. If the Examiner has any questions concerning the present Amendment, the Examiner is kindly requested to contact the undersigned at (408) 749-6900, ext. 6913. If any additional fees are due in connection with filing this Amendment, the Commissioner is also authorized to charge Deposit Account No. 50-0805 (Order No. LAM2P216).

Respectfully submitted,  
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